

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Cohen, et al.	Customer No:	32107
Assignee:	Microfabrica Inc.	Docket No:	P-US024-A-MF
Title:	Method for Electrochemically Forming Structures Including Non-Parallel Mating of Contact Masks and Substrates		
Application No:	10/724,515	Filing Date:	November 26, 2003
Examiner:	Culbert, Roberts P.	Group Art Unit:	1763

COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, VA 22313-1450

August 8, 2007

AMENDMENT

Dear Sir:

Applicant makes this submission in response to the Office action dated February 8, 2007 for the above noted application.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 10 of this paper.